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#### **UART-Interface:**

**Transfer rate:** 

HTPA8x8: Send/receive: 460800 baud HTPA16x16: Send/receive: 115200 baud HTPA32x31: Send/receive: 460800 baud HTPA32x31: Send/receive: 460800 baud

**Protocol Specifications:** 

Data format: 8N1 (8 data bits, no parity, 1 stop bit)

Flow Control: NONE Local Options: Raw Input

Voltage and Temperature Output

**Electrical Specifications:** 

VDD: Supply (+3.3V DC)

UART Transmit/Receive: TTL VSS GND

**Power Supply:** 3.3 VDC +/- 5%, 300mA

IDD (Idle mode) 75 mA IDD (Operating mode) 135 mA

#### **Pinout:**

No.	Function	Туре
1	VDD	Power
2	VDD	Power
	VSS	Power
4	VSS	Power
5	SS#	Input
6	UTX/SDO **	Output
7	URX/SDI **	Input
8	SCK	Input
9	CTX*	Output
10	CRX*	Input

\* Pins planned for CAN Bus.

\*\* URX/UTX is used for the UART Module

SDI/SDO/SS#/SCK pins support the Module with SPI Interface.

Connector layout: see drawings.

## **Ethernet-Interface:**

**Protocol Specifications:** 

Protocol type: UDP All communication on Port: 30444

#### Power connection at Ethernet device:



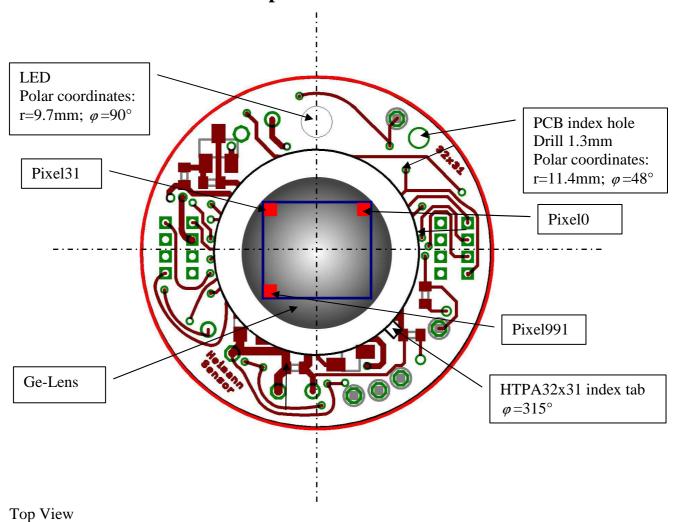
1 VSS (-) GND 2 VDD (+) Supply (+3.3V DC)

**Power Supply:** 3.3 VDC +/- 5%, 300mA

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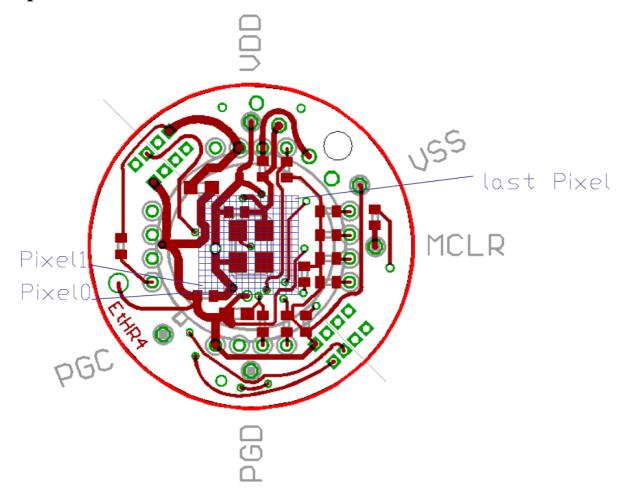
## **HTPA32x31 UDP Module Optical Orientation of Pixels:**



# HTPA Module Specifications and Transferprotocol Rev.1.21: 2012.07.19 Fg



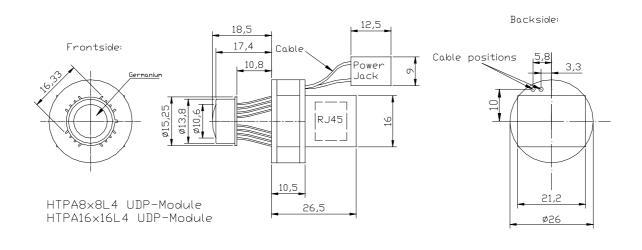
# **Optical Orientation HTPA16x16 UDP Module:**

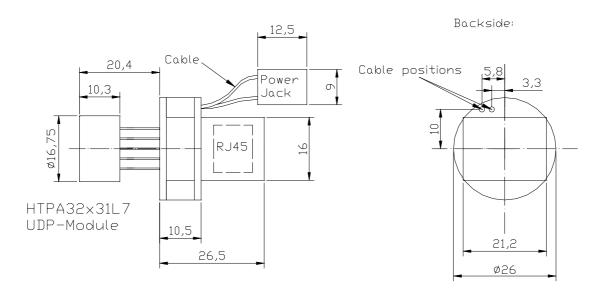


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#### **Module dimensions:**



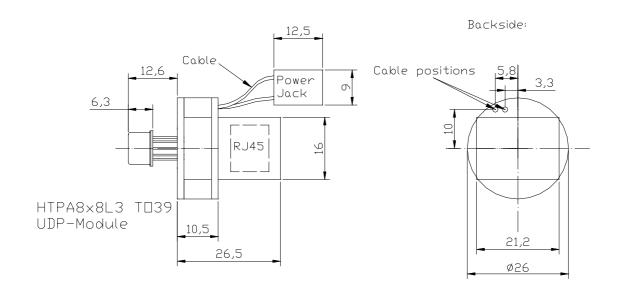


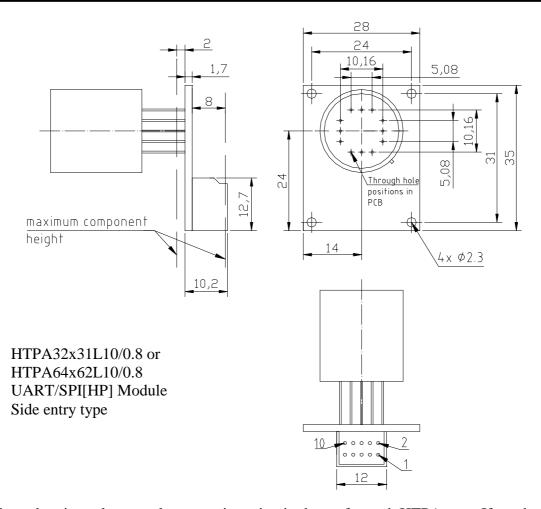
In these drawings always only one optic option is shown for each HTPA type. If another optic is built in, refer to the datasheet of the HTPA sensor. PCB size, pin length of the HTPA and positions on the PCB remain the same, only the cap of the HTPA changes.

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### **Module dimensions (continued):**



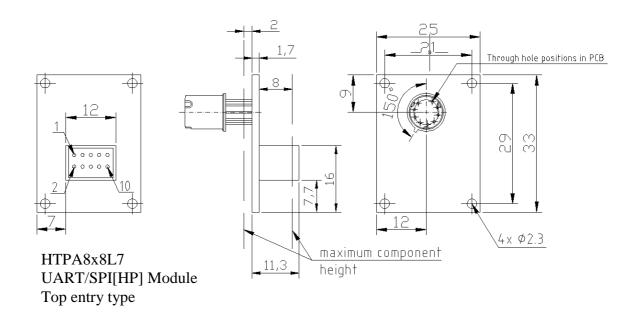


In these drawings always only one optic option is shown for each HTPA type. If another optic is built in, refer to the datasheet of the HTPA sensor. PCB size, pin length of the HTPA and positions on the PCB remain the same, only the cap of the HTPA changes.

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## **Module dimensions (continued):**



In these drawings always only one optic option is shown for each HTPA type. If another optic is built in, refer to the datasheet of the HTPA sensor. PCB size, pin length of the HTPA and positions on the PCB remain the same, only the cap of the HTPA changes.

# HTPA Module Specifications and Transferprotocol Rev.1.21: 2012.07.19 Fg



## **Communication:**

Sent						Com	munication	via Termina	! / UDP											
Char	HTPA8x8	HTPA16x16	HTPA32x31 HTPA64x62	Result/Received message																
'a'	X	X	X		the operating f															
'A'	X	X	X		the operating fr															
'b'	X	X	X		/DD (reference				CII :C · ·	TIADE 1:		LIDD								
'C'	X	X	v		ngle voltage fra			_												
'c' 'd'/'D'	X	X	X	Toggle PC	ngle voltage fra	ime. Use AD	C of µC. Out	put via ASCI	i ii sent via U	AK 1, binary	ii sent via C	DP.								
'f'	X	X	X	Toggle Re																
F	X	X	2.		erating point is	at start of A	D-range, only	positive sign	als convertab	ole										
'G'	X	X			erating point is						able									
'g'	X	X			erating point is															
'h'	X	X	X		ary EEDATA		<u> </u>													
'i'			X	•	le voltage fram		ASCII format	Serial order	Pixeldata[K	*10], el. Offs	ets, Ambient	Temperati	ure							
T'			X		le temperature f															
'J'	X	X	X	Toggle Ar	npli fication															
'k'	X	X	X		le temperature f															
'K'	X	X	X	send conti	nous binary ten	nperature dat	astream(µC-A	ADC)[K*10]												
				Output of	a complete cyc	le in this orde	er:													
				Н	TPA 8x8 and H	TPA 16x16: P	ixel0,Pixel1,	PixelX, el	Offset0, el.Of	fset1,, el.C	OffsetY,PTAT	0,PTAT1,	.,PTATZ							
								HTPA32x3	: see Table2.											
						Fe	or a detailed .	Description of	of the serial o	rder see Tab	le2.									
				16x16 Am	•		Array:													
				X=255; Y	=/; <b>Z</b> =/	X=6	3; Y=4; Z=4													
				One datas	at has avactly 2	bytee: first tl	a low Byta i	s cand than t	ha high byta	Each Datase	t contains the	magaurad								
					-	-	-	One dataset has exactly 2 bytes: first the low-Byte is send, then the high-byte. Each Dataset contains the measured Temperature in												
				Kelvin*10. The first 4 datasets el. Offset0el. Offset3 after the last Pixel voltage PixelX transmit additional the current VDD									-							
				in the MS		iascis ei.Ojjsi	et0el.Offsei	3 after the la					-							
						lasets et.Ojjsi	et0el.Offsei	3 after the la					-							
						laseis ei.Ojjsi				ge <i>PixelX</i> tra	nsmit additi		-							
						Bit14			st Pixel volta	ge <i>PixelX</i> tra	nsmit additi		-							
				in the MS	B's:		VDD and T	Amb for H	st Pixel volta	ge PixelX tra	nsmit additi	onal the cur	rrent VDD							
				in the MS	Bis:		VDD and T	Amb for H7	st Pixel volta  PA8x8 and I	ge PixelX tra	nsmit additi	onal the cur	Bit 0							
				in the MS	B's:  Bit 15  MSB VDD		VDD and T	Amb for HT Bit12 Bit12 VDD	St Pixel volta  (PA8x8 and )  Bit 11  MSB elOff0	ge PixelX tra	nsmit additi	onal the cur	Bit 0 LSB elOff0							
				in the MS	B's:  Bit 15  MSB VDD Bit 11 VDD		VDD and T	Amb for H7 Bit12 Bit12 VDD Bit8 VDD	St Pixel volta	ge PixelX tra	nsmit additi	onal the cur	Bit 0 LSB elOff 0 LSB elOff 1							
				Dataset elOff0 elOff1 elOff2 elOff3	Bit15  MSB VDD Bit11 VDD Bit7 VDD Bit3 VDD	Bit14	VDD and T	Amb for H7 Bit12 Bit12 VDD Bit8 VDD Bit4 VDD LSB VDD	SE Pixel volta  PA8x8 and I  Bit 11  MSB eOff0  MSB eOff1  MSB eOff2  MSB eOff3	ge PixelX tra	nsmit additi	onal the cur	Bit 0  LSB elOff 0  LSB elOff 1  LSB elOff 2							
				Dataset elOff0 elOff1 elOff2 elOff3 The Senso	B's:  Bit 15  MSB VDD Bit 11 VDD Bit 7 VDD Bit 3 VDD or temperature i	Bit14 s available in	VDD and T Bit13 the datasets	Amb for HT Bit12 Bit12 VDD Bit8 VDD Bit4 VDD LSB VDD	ST Pixel volta  EPA8x8 and I  Bit11  MSB eOff0  MSB eOff1  MSB eOff2  MSB eOff3  3:	ge PixelX tra	nsmit additi	Bit1	BirO LSB elOffO LSB elOffO LSB elOffI LSB elOff3							
				Dataset elOff0 elOff1 elOff2 elOff3 The Senso	Bis 15  MSB VDD Bit 11 VDD Bit 7 VDD Bit 3 VDD or temperature i Bit 15	Bit14	VDD and T	Amb for HT Bit12 Bit12 VDD Bit8 VDD Bit4 VDD LSB VDD after el.Offse Bit12	TPA8x8 and I Bit 11 MSB eOff0 MSB eOff1 MSB eOff2 MSB eOff3 3: Bit 11	ge PixelX tra	nsmit additi	onal the cur	Bit 0  LSB elOff 0  LSB elOff 1  LSB elOff 2  LSB elOff 3							
				Dataset elOff0 elOff2 elOff3 The Senso Dataset elOff3+1	Bis:  Bis 15  MSB VDD Bis 11 VDD Bis 7 VDD Bis 3 VDD  or temperature i Bis 15  MSB TAmb	Bit14 s available in	VDD and T Bit13 the datasets	Amb for H7  Bit 2  Bit 2 VDD  Bit8 VDD  Bit4 VDD  LSB VDD  after el. Offse  Bit 2 TAmb	EPA8x8 and I Bit 11 MSB eOff0 MSB eOff1 MSB eOff2 MSB eOff3 3: Bit 11 MSB eOff3+1	ge PixelX tra	nsmit additi	Bit1	Bit 0 LSB elOff0 LSB elOff1 LSB elOff2 LSB elOff3 Bit 0 LSB elOff3+1							
				Dataset elOff0 elOff1 elOff2 elOff3 The Senso Dataset elOff3+1 elOff3+2	Bis:  Bis 15  MSB VDD Bis 11 VDD Bis 7 VDD Bis 3 VDD  or temperature i Bis 15  MSB Tamb Bis 11 Tamb	Bit14 s available in	VDD and T Bit13 the datasets	Amb for HT  Bit 2  Bit 1 2 VDD  Bit 8 VDD  Bit 4 VDD  LSB VDD  After el. Offse  Bit 1 2  Bit 1 2 TAmb  Bit 8 TAmb	SE Pixel volta  EPA8x8 and I  Bit 11  MSB eOff0  MSB eOff1  MSB eOff3  3:  Bit 11  MSB eOff3+1  MSB eOff3+2	ge PixelX tra	nsmit additi	Bit1	Bit 0 LSB elOff0 LSB elOff1 LSB elOff2 LSB elOff3 Bit 0 LSB elOff3+1 LSB elOff3+2							
				in the MSI  Dataset elOff0 elOff3  The Senso  Dataset elOff3+1 elOff3+2 elOff3+3	B's:  Bit 15  MSB VDD Bit 11 VDD Bit 7 VDD Bit 3 VDD  or temperature i Bit 15  MSB TAmb Bit 11 TAmb Bit 7 TAmb	Bit14 s available in	VDD and T Bit13 the datasets	Amb for HT Bit 2 Bit 2 VDD Bit 8 VDD Bit 4 VDD LSB VDD after el. Offse Bit 2 Bit 2 TAmb Bit 8 TAmb	SE Pixel volta  EPA8x8 and I  Bit 11  MSB e0ff0  MSB e0ff1  MSB e0ff3  3 :  Bit 11  MSB e0ff3+1  MSB e0ff3+1  MSB e0ff3+2  MSB e0ff3+3	ge PixelX tra	nsmit additi	Bit1	Bit 0 LSB elOff0 LSB elOff1 LSB elOff2 LSB elOff3  Bit 0 LSB elOff3+1 LSB elOff3+2 LSB elOff3+3							
				Dataset elOff0 elOff1 elOff2 elOff3  The Senso Dataset elOff3+1 elOff3+2	Bis:  Bis 15  MSB VDD Bis 11 VDD Bis 7 VDD Bis 3 VDD  or temperature i Bis 15  MSB Tamb Bis 11 Tamb	Bit14 s available in	VDD and T Bit13 the datasets	Amb for HT Bit 12 Bit 12 VDD Bit 8 VDD Bit 4 VDD LSB VDD after el. Offsee Bit 12 TAmb Bit 8 TAmb Bit 4 TAmb	SE Pixel volta  EPA8x8 and I  Bit 11  MSB eOff0  MSB eOff1  MSB eOff3  3:  Bit 11  MSB eOff3+1  MSB eOff3+2	ge PixelX tra	nsmit additi	Bit1	Bit 0 LSB elOff0 LSB elOff1 LSB elOff2 LSB elOff3 Bit 0 LSB elOff3+1 LSB elOff3+2							
T	X	X	x	in the MSi  Dataset elOff0 elOff2 elOff3  The Senso Dataset elOff8+1 elOff6+2 elOff6+3 elOff6+4 elOff6+5	B's:  Bit 15  MSB VDD Bit 11 VDD Bit 7 VDD Bit 3 VDD  or temperature i Bit 15  MSB TAmb Bit 11 TAmb Bit 7 TAmb	Bit14 s available in Bit14	VDD and T  Bit13 the datasets Bit13	Amb for H7  Bit 2  Bit 2 VDD  Bit8 VDD  Bit8 VDD  LSB VDD  after el. Offse  Bit 2 TAmb  Bit8 TAmb  Bit4 TAmb	SE Pixel volta  EPA8x8 and I Bit I1 MSB eloff0 MSB eloff1 MSB eloff3  3: Bit I1 MSB eloff3+1 MSB eloff3+2 MSB eloff3+3 MSB eloff3+4 MSB eloff3+4 MSB eloff3+4 MSB eloff3+5	ge PixelX tra  HTPA16x16  Bit10	is:	Bit1	Bit 0  LSB elOff0 LSB elOff1 LSB elOff2 LSB elOff3  Bit 0  LSB elOff3+1 LSB elOff3+2 LSB elOff3+2 LSB elOff3+3 LSB elOff3+4							
T' 'm'	XXX	X	X X	in the MSi  Dataset elOff0 elOff2 elOff3  The Senso Dataset elOff6+1 elOff6+2 elOff6+3 elOff6+4 elOff6+5  Get Ambio	Bis:  Bis15  MSB VDD  Bis11 VDD  Bis7 VDD  Bis3 VDD  or temperature i  Bis15  MSB TAmb  Bis11 TAmb  Bis1 TAmb	Bit14 s available in Bit14	WDD and T Bitl3 the datasets Bitl3 the Ambient	Amb for H7  Bit 2  Bit 2 VDD  Bit8 VDD  Bit8 VDD  LSB VDD  after el. Offse  Bit 2 TAmb  Bit 2 TAmb  LSB TAmb  Temperature	TPA8x8 and I Bit II MSB eloff0 MSB eloff1 MSB eloff3  3: Bit II MSB eloff3+I MSB eloff3+I MSB eloff3+2 MSB eloff3+3 MSB eloff3+4 MSB eloff3+5 from the last	Bitto  Bi	is:	Bat Bat Bat	Bit 0  LSB elOff0  LSB elOff1  LSB elOff2  LSB elOff3  Bit 0  LSB elOff3+1  LSB elOff3+2  LSB elOff3+3  LSB elOff3+4  LSB elOff3+5							
				Dataset eloff0 eloff1 eloff2 eloff3  The Senso Dataset eloff3+1 eloff3+2 eloff3+3 eloff3+3 eloff3+4 eloff3+5  Get Ambir Toggle us:	B's:  Bit 15  MSB VDD Bit 1 VDD Bit 7 VDD Bit 3 VDD or temperature i Bit 15  MSB TAmb Bit 1 TAmb Bit 3 TAmb Coent Temperature	Bit14 s available in Bit14 c (Calculates	WDD and T Bitl3 the datasets Bitl3 the Ambient ets (Stack de	Amb for H7  Bit 2  Bit 2 VDD  Bit VDD  Bit VDD  LSB VDD  After el. Offse  Bit 2 TAmb  Bit 2 TAmb  Bit 3 TAmb  LSB TAmb  Temperature  pth = 64 for 1	TPA8x8 and I Bit II MSB eOff0 MSB eOff1 MSB eOff3  3: Bit II MSB eOff3+1 MSB eOff3+2 MSB eOff3+4 MSB eOff3+4 MSB eOff3+5 from the last HTPA8x8 and	Bitto  Bi	is:	Bat Bat Bat	Bit 0  LSB elOff 0  LSB elOff 1  LSB elOff 3  Bit 0  LSB elOff 3+1  LSB elOff 3+2  LSB elOff 3+3  LSB elOff 3+4  LSB elOff 3+5							
'm'	X	X	X	in the MSi  Dataset eloff0 eloff1 eloff2 eloff3 The Senso Dataset eloff6+1 eloff6+2 eloff6+2 eloff6+4 eloff6+4 Soff6+3 Get Ambio Toggle uss Shows cur	Bis:  Bis 15  MSB VDD  Bis 11 VDD  Bis 7 VDD  Bis 3 VDD  or temperature i  Bis 15  MSB TAmb  Bis 11 TAmb  Bis 7 TAmb  Cent Temperature  age of \( \mu C-Buffer	Bit14 s available in Bit14 e (Calculates er for el. Offs ation settings	bit13 the datasets bit13 the datasets bit13 the Ambient ets (Stack de	Amb for H7  Bit 2  Bit 2 VDD  Bit8 VDD  Bit8 VDD  Bit4 VDD  LSB VDD  after el. Offse  Bit 2 TAmb  Bit 2 TAmb  Bit 3 TAmb  LSB TAmb  Temperature  pth = 64 for 1s the following starts of the following starts.	TPA8x8 and I Bit II MSB dOff0 MSB dOff1 MSB dOff2 MSB dOff3  3: Bit II MSB dOff3+1 MSB dOff3+2 MSB dOff3+2 MSB dOff3+5 from the last HTPA8x8 and ng stream:	Bitto	is:	Bit       Bit	Bit 0  LSB elOff0  LSB elOff1  LSB elOff3  Bit 0  LSB elOff3+1  LSB elOff3+2  LSB elOff3+3  LSB elOff3+4  LSB elOff3+5  HTPA32x31)							
'm'	X	X	X	in the MSi  Dataset eloff0 eloff1 eloff2 eloff6 The Senso Dataset eloff8+1 eloff8+2 eloff8+3 Get Ambi- Toggle uss Shows cur "HTPA si	Bis:  Bis:15  MSB VDD  Bis:11 VDD  Bis:7 VDD  Bis:3 VDD  or temperature i  Bis:15  MSB TAmb  Bis:11 TAmb  Bis:3 TAmb  Cent Temperature  age of \( \mu C-Buffirer \)  Temperature and calibrates	Bit14 s available in Bit14 e (Calculates er for el. Offs ation settings	bit13 the datasets bit13 the Ambient ets (Stack de Device prin	Amb for HT  Bit 2  Bit 2 VDD  Bit VDD  Bit VDD  Bit VDD  Start Plotter el. Offse  Bit 12  Bit 12 TAmb  Bit 12 TAmb  Bit TAmb  LSB TAmb  Temperature  pth = 64 for 1s  s the following sible values	TPA8x8 and I Bit II MSB eOff0 MSB eOff1 MSB eOff3  3: Bit II MSB eOff3+1 MSB eOff3+2 MSB eOff3+2 MSB eOff3+5 from the last HTPA8x8 and ng stream: for X: "0"=H:	Bitto Bitto Bitto IIII Bitto IIIII Bitto IIII Bitto III	is:	Bit	Bit 0  LSB elOff0  LSB elOff1  LSB elOff3  Bit 0  LSB elOff3+1  LSB elOff3+2  LSB elOff3+3  LSB elOff3+4  LSB elOff3+5  HTPA32x31)							
'm'	X	X	X	in the MSi  Dataset eloff0 eloff1 eloff2 eloff6 The Senso Dataset eloff6+1 eloff6+2 eloff6+3 eloff6+3 Get Ambi Toggle uss Shows cur "HTPA s"	Bis:  Bis:15  MSB VDD Bis:11 VDD Bis:7 VDD Bis:3 VDD  or temperature i Bis:15  MSB TAmb Bis:11 TAmb Bis:3 TAmb Cent Temperature age of \( \mu C-Buffirer \)  reries responsed	Bit14 s available in Bit14 e (Calculates er for el. Offs ation settings !! I am Arra ten by B.Fon	bit13  the datasets bit13  the Ambient lets (Stack de Device prin ytype X'' Perg; Heimann	Amb for HT  Bit12 Bit12 VDD Bit8 VDD Bit8 VDD Bit8 VDD After el. Offsee Bit12 Bit12 TAmb Bit8 TAmb Bit8 TAmb LSB TAmb Temperature pth = 64 for stee following stible values Sensor Gm	TPA8x8 and I Bit II MSB eloff0 MSB eloff1 MSB eloff3 3: Bit II MSB eloff3+1 MSB eloff3+2 MSB eloff3+2 MSB eloff3+5 from the last TPA8x8 and ng stream: for X: "0"=H: bH; YYYY-M	Bitto Bitto Bitto IIII Bitto IIIII Bitto IIII Bitto III	is:	Bit	Bit 0  LSB elOff0  LSB elOff1  LSB elOff3  Bit 0  LSB elOff3+1  LSB elOff3+2  LSB elOff3+3  LSB elOff3+4  LSB elOff3+5  HTPA32x31)							
'm'	X	X	X	in the MSi  Dataset elOff0 elOff1 elOff2 elOff5 The Senso Dataset elOff6+1 elOff6+2 elOff6+3 elOff6+5 Get Ambin Toggle uss Shows cur "HTPA s' "Firmwai "I am rur	Bis:  Bis:15  MSB VDD  Bis:11 VDD  Bis:7 VDD  Bis:3 VDD  or temperature i  Bis:15  MSB TAmb  Bis:11 TAmb  Bis:7 TAmb  Bis:3 TAmb  cent Temperature  age of \( \mu C-Buff)  rent and calibra  eries response  rev.X.XX write	Bitl4 s available in Bitl4 e (Calculates er for el. Offs ation settings l! I am Arra ten by B.Foi	the datasets Bit13 the datasets Bit13 the Ambient tets (Stack de Device prin ytype X'' Porg; Heimann ctual MCLK-	Amb for HT  Bit12 Bit12 VDD Bit8 VDD Bit8 VDD LSB VDD  After el. Offsee Bit12 Bit12 TAmb Bit8 TAmb Bit8 TAmb LSB TAmb CSB TAmb Temperature pth = 64 for 1 s the following sible values Sensor Gm setting in kH	TPA8x8 and I Bit II MSB eloff0 MSB eloff1 MSB eloff3 3: Bit II MSB eloff3 3: Bit II MSB eloff3+1 MSB eloff3+2 MSB eloff3+3 MSB eloff3+3 MSB eloff3+3 MSB eloff3+4 MSB eloff3+4 MSB eloff3+5 from the last HTPA8x8 and mg stream: for X: "0"=H; bH; YYYY-Mz	Bit10  Bi	is:	Bit	Bit 0  LSB elOff0  LSB elOff1  LSB elOff3  Bit 0  LSB elOff3+1  LSB elOff3+2  LSB elOff3+3  LSB elOff3+4  LSB elOff3+5  HTPA32x31)							
'm'	X	X	X	in the MSi  Dataset elOff0 elOff3  The Senso Dataset elOff3+1 elOff3+2 elOff3+3 elOff3+3 elOff3+5  Get Ambin Toggle us: "HTPA s: "Firmwa: "I am rur "Amplific	Bis:  Bis:5  MSB VDD Bis:1 VDD Bis:7 VDD Bis:3 VDD  Fretemperature i Bis:15  MSB TAmb Bis:1 TAmb Bis:3 TAmb Compare the Temperature age of \( \mu \)C-Buff Tent and calibrieries responsed to the v.X.XX writing on XXX	Bitl4 s available in Bitl4 e (Calculates er for el. Offs ation settings !! I am Arra ten by B.Foi	the datasets  Bit13 the datasets  Bit13 the Ambient ets (Stack de Device prin ytype X'' Po	Amb for HT  Bit12  Bit12 VDD  Bit8 VDD  Bit8 VDD  LSB VDD  After el. Offsee  Bit12  Bit12 TAmb  Bit8 TAmb  Bit8 TAmb  LSB TAmb  Temperature  pth = 64 for 1  st the following sible values  Sensor Gm  setting in kH  possible string	ST Pixel volta  Bit II  MSB dOff0  MSB dOff1  MSB dOff3  3:  Bit II  MSB dOff3+1  MSB dOff3+2  MSB dOff3+3  MSB dOff3+3  MSB dOff3+3  MSB dOff3+5  From the last  HTPA8x8 and  ng stream:  for X: "0"=H:  bH; YYYY-M  z  s for X: "low"	Bit10  Bi	rismit additions and additions and additions are additional and a second a second and a second a	Bit	Bit 0  LSB elOff0  LSB elOff1  LSB elOff3  Bit 0  LSB elOff3+1  LSB elOff3+2  LSB elOff3+3  LSB elOff3+4  LSB elOff3+5  HTPA32x31)							
'm'	X	X	X	in the MSi  Dataset elOff0 elOff1 elOff2 elOff6 The Senso Dataset elOff6+1 elOff6+2 elOff6+3 elOff6+4 elOff6+5 Get Ambir Toggle us: "HTPA s "Firmwa" "I am rur "Amplific "MA C-III	Bis:  Bis:5  MSB VDD Bis:1 VDD Bis:7 VDD Bis:7 VDD Bis:3 VDD  or temperature i Bis:15  MSB TAmb Bis:1 TAmb Bis:1 TAmb Bis:3 TAmb Cent Temperature age of µC-Buff rent and calibrateries responseer re v.X.XX writening on XXX cation is X'' Advanced.	Bitl4 s available in Bitl4 ce (Calculates er for el. Offs ation settings !! I am Arra ten by B.Foi X.X kHz" Ac etual set amp ID: Z\r\n"	the datasets  Bit13 the datasets  Bit13 the Ambient ets (Stack de Device prin ytype X'' Po 'g; Heimann ctual MCLK- blification. Po Only Etherno	Amb for HT  Bit12  Bit12 VDD  Bit8 VDD  Bit4 VDD  LSB VDD  after el. Offsee  Bit12  Bit12 TAmb  Bit8 TAmb  Bit4 TAmb  LSB TAmb  Temperature  pth = 64 for 1  s the following sible values  Sensor Gm  setting in kH  ossible string at devices shot	SE Pixel volta  SEPASS and D  Bit11  MSB e0ff0  MSB e0ff1  MSB e0ff3  3 :  Bit11  MSB e0ff3+1  MSB e0ff3+1  MSB e0ff3+2  MSB e0ff3+4  MSB e0ff3+5  from the last  TPASX8 and mag stream:  for X: "0"=H  bH; YYYY-M  Z  S for X: "low"  w a MAC-ID	Bit10  Bit10  Bit10  Image PixelX tra  Bit10	ansmit additions:	Bat	Bir 0  LSB elOff0 LSB elOff1 LSB elOff2 LSB elOff3  Bir 0  LSB elOff3+1 LSB elOff3+2 LSB elOff3+3 LSB elOff3+4 LSB elOff3+5  HTPA32x31)							

**Table1:** Control Characters

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#### **Table1, continuation:**

	Communication via Terminal / UDP												
Sent Char	HTPA8x8	HTPA16x16	HTPA32x31 HTPA64x62	Result/Received message									
'o'		X	X	Use extern	al reference v	oltages							
'O'		X	X	Use interna	al reference v	oltages							
'q'/'Q'	X	X	X	Allow Cha	nges (require	d for Calibra	ation)						
't'	X	X	X	Continuou	s binary volta	ge data of th	ne μC-ADC	is transmitted.					
				Output of a	a complete cy	cle in this or	rder:						
				НТ	PA 8x8 and F			ll,PixelX, e HTPA32x3 ed Description	31: see Table2	2.		ATO,PTAT1,.	,PTATZ
				16x16 Arra X=255; Y=	-		x8 Array: =63; Y=4; Z	=4					
						•	ffset3 after t	te is send, then he last Pixel vo  DD for HTPA8	ltage PixelX	transmit add			
				Dataset	Bit 15	Bitl4	Bit13	Bit12	Bit 11	Bit10		B it1	Bit 0
				elOff0	MSB VDD			Bit12 VDD	MSB elOff0				LSB elOff0
				elOffl	Bit 11 VDD			Bit8 VDD	MSB elOff1				LSB elOff1
				elOff2	Bit 7 VDD			Bit4 VDD	MSB elOff2				LSB elOff2
				elOff3	Bit 3 VDD			LSB VDD	MSB elOff3				LSB elOff3
'T'	X	X		Continuou	s binary data	of the ASIC	-ADC is trai	nsmitted.					
					ler is equal to								
'u'	X	X			•		-ADC is trai	nsmitted. PTAT	'-Voltages are	sampled w	ith the uC-A	DC.	
					er is equal to								
'U'	X	X		•			•	t via ASCII. PI	TAT-Voltages	are sample	d with the u	C-ADC.	
'v'	X	X	X		IP (Only Ethe								
'V'	X	X	X		aits control m		y non-Ethern	et devices)					
'w'	X	X	X		ibration-const								
'W'	X	X	X		ı. ATTENTIC		aset cannot l	be restored!					
'x'	X	X	X		am without pr	_							
'X'	X	X	X		am by sending		n"						-
'y'	X	X	X	switch off	ASIC-Supply	(5V)							
'Y'	X	X	X	switch on A	ASIC-Supply	(5V)							

**Table1 (continuation):** Control Characters

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### **Serial order in Frame:**

	HTPA8x8 Temperature Mode
Dataset	Value
C	Temperature of Pixel0 in K*10
1	Temperature of Pixel1 in K*10
2	Temperature of Pixel2 in K*10
3	Temperature of Pixel3 in K*10
63	Temperature of Pixel63 in K*10
64	4 bits of VDD and elOff0 in digits (refer to Table1)
65	4 bits of VDD and elOff1 in digits (refer to Table1)
66	4 bits of VDD and elOff2 in digits (refer to Table1)
67	4 bits of VDD and elOff4 in digits (refer to Table1)
68	4 bits of TAmb and PTAT0 in digits (refer to Table1)
68	4 bits of TAmb and PTAT1 in digits (refer to Table1)
68	4 bits of TAmb and PTAT2 in digits (refer to Table 1)
68	4 bits of TAmb and PTAT3 in digits (refer to Table1)

	UTD A16 v16 Tomporoturo Modo
	HTPA16x16 Temperature Mode
Dataset	Value
0	Temperature of Pixel 0 in K*10
1	Temperature of Pixel1 in K*10
2	Temperature of Pixel2 in K*10
3	Temperature of Pixel 3 in K*10
	.
255	Temperature of Pixel 255 in K*10
256	4 bits of VDD and elOff0 in digits (refer to Table1)
257	4 bits of VDD and elOff1 in digits (refer to Table1)
258	4 bits of VDD and elOff2 in digits (refer to Table1)
259	4 bits of VDD and elOff3 in digits (refer to Table1)
260	elOff4 in digits
261	elOff5 in digits
262	elOff6 in digits
263	elOff7 in digits
264	4 bits of TAmb and PTAT0 in digits (refer to Table 1)
265	4 bits of TAmb and PTAT1 in digits (refer to Table1)
266	4 bits of TAmb and PTAT2 in digits (refer to Table1)
267	4 bits of TAmb and PTAT3 in digits (refer to Table 1)
268	PTAT4 in digits
 271	PTAT7 in digits

HTPA8x8 Voltage Mode						
Dataset		Value				
	0	absolute Voltage of Pixel0 in digits				
	1	absolute Voltage of Pixel1 in digits				
	2	absolute Voltage of Pixel2 in digits				
	3	absolute Voltage of Pixel3 in digits				
	63	absolute Voltage of Pixel63 in digits				
	64	4 bits of VDD and elOff0 in digits (refer to Table1)				
	65	4 bits of VDD and elOff1 in digits (refer to Table1)				
	66 4 bits of VDD and elOff2 in digits (refer to Table1)					
	67	4 bits of VDD and elOff4 in digits (refer to Table1)				
	68 4 bits of TAmb and PTAT0 in digits (refer to Table					
	68	4 bits of TAmb and PTAT1 in digits (refer to Table1)				
	68	4 bits of TAmb and PTAT2 in digits (refer to Table1)				
	68	4 bits of TAmb and PTAT3 in digits (refer to Table1)				

	HTPA16x16 Voltage Mode
Dataset	Value
(	absolute Voltage of Pixel0 in digits
	absolute Voltage of Pixel1 in digits
2	absolute Voltage of Pixel2 in digits
;	absolute Voltage of Pixel3 in digits
25	absolute Voltage of Pixel255 in digits
256	4 bits of VDD and elOff0 in digits (refer to Table1)
25	4 bits of VDD and elOff1 in digits (refer to Table1)
258	3 4 bits of VDD and elOff2 in digits (refer to Table1)
259	4 bits of VDD and elOff3 in digits (refer to Table1)
260	elOff4 in digits
26	elOff5 in digits
26	elOff6 in digits
26	B elOff7 in digits
26	4 bits of TAmb and PTAT0 in digits (refer to Table1)
26	4 bits of TAmb and PTAT1 in digits (refer to Table1)
	4 bits of TAmb and PTAT2 in digits (refer to Table1)
	4 bits of TAmb and PTAT3 in digits (refer to Table 1)
26	PTAT4 in digits
	· <u> </u>
27 <sup>-</sup>	IPTAT7 in digits

Table2: Serial order

Each dataset consists of a 16 bit value. If a frame consists out of more than one packet, packets are appended. For UART devices the 16 bit values are transmitted with LSB first.

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	HTPA32x31 Temperature Mode
Dataset	Value
	Temperature of Pixel 0 in K*10
	Temperature of Pixel 16 in K*10
	Temperature of Pixel 1 in K*10
	Temperature of Pixel 17 in K*10
3	Temperature of Fixer 17 III K 10
30	Temperature of Pixel 15 in K*10
	Temperature of Pixel 31 in K*10
	Temperature of Pixel 32 in K*10
	Temperature of Pixel 48 in K*10
	<u>'</u>
	Temperature of Pixel 991 in K*10
	elOff0 in digits
	elOff16 in digits
	elOff1 in digits
	elOff17 in digits
990	
1022	elOff15 in digits
	elOff31 in digits
	least significant 12 bits of VDD
	most significant 4 bits of VDD
	least significant 12 bits of TAmb
	most significant 4 bits of TAmb
	no value, ignore
	no value, ignore
1023	Tho value, ignore
1030	no value, ignore
	PTAT0 in digits
	no value, ignore
	PTAT1 in digits
	no value, ignore
	PTAT7 in digits
	no value, ignore
1000	Ino value, ignore

	HTPA32x31 Voltage Mode
Dataset	Value
0	absolute Voltage of Pixel0 in digits
	absolute Voltage of Pixel16 in digits
	absolute Voltage of Pixel1 in digits
3	absolute Voltage of Pixel17 in digits
30	 absolute Voltage of Pixel15 in digits
	9
	absolute Voltage of Pixel31 in digits absolute Voltage of Pixel32 in digits
	absolute Voltage of Pixel48 in digits
	 absolute Voltage of Pixel991 in digits
	elOff0 in digits
	elOff16 in digits
	elOff1 in digits
	elOff17 in digits
995	
1022	elOff15 in digits
	elOff31 in digits
	least significant 12 bits of VDD
	most significant 4 bits of VDD
	no value, ignore
	no value, ignore
	no value, ignore
1029	no value, ignore
1039	no value, ignore
1040	PTAT0 in digits
1041	no value, ignore
1042	PTAT1 in digits
	no value, ignore
	PTAT7 in digits
1055	no value, ignore

	HTPA64x62 Temperature Mode
Dataset	Value
0	Temperature of Pixel 0 in K*10
1	· ·
2	Temperature of Pixel1 in K*10
3	Temperature of Pixel33 in K*10
62	Temperature of Pixel31 in K*10
63	Temperature of Pixel63 in K*10
64	Temperature of Pixel64 in K*10
65	Temperature of Pixel96 in K*10
	Temperature of Pixel3967 in K*10
	elOff0 in digits
	elOff32 in digits
	elOff1 in digits
3971	elOff33 in digits
	elOff31 in digits
	elOff63 in digits
	least significant 12 bits of VDD
	most significant 4 bits of VDD
	least significant 12 bits of TAmb
	most significant 4 bits of TAmb
	no value, ignore
	no value, ignore
	no value, ignore
	PTAT0 in digits
	PTAT1 in digits
4050	PTAT2 in digits
4063	PTAT15 in digits
	no value, ignore
	no value, ignore
	no value, ignore
4095	Ino value, ignore

Value
absolute Voltage of Pixel0 in digits
absolute Voltage of Pixel32 in digits
2 absolute Voltage of Pixel1 in digits
B absolute Voltage of Pixel33 in digits
 ≀absolute Voltage of Pixel31 in digits
B absolute Voltage of Pixel63 in digits
absolute Voltage of Pixel64 in digits
absolute Voltage of Pixel96 in digits
absolute Voltage of Pixel3967 in digits
B elOff0 in digits
elOff32 in digits
elOff1 in digits
elOff33 in digits
elOff31 in digits
elOff63 in digits
least significant 12 bits of VDD
most significant 4 bits of VDD
no value, ignore
· ···
no value, ignore
PTAT0 in digits
PTAT1 in digits
PTAT2 in digits
· PTAT15 in digits
no value, ignore
no value, ignoreno value, ignore
no value, ignore

Table2 (continuation): Serial order

Each dataset consists of a 16 bit value. If a frame consists out of more than one packet, packets are appended. For UART devices the 16 bit values are transmitted with LSB first.

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### Packets (UDP, only Ethernet device):

Number of packets	Packet size [byte]	HTPA type	Comments
1	144	HTPA8x8	-
1	544	HTPA16x16	-
2	1058+1054	HTPA32x31	see below for details
8	1101+621	HTPA64x62	see below for details

Packet details for HTPA32x31					
Packet No.	Packet size	Packet contains			
1	1058	Data of Pixel0 - Pixel528			
2	1054	Data of Pixel529 to end of frame			

Packet details for HTPA64x62				
Packet No.	Packet size	Packet contains		
1	1101	Packet index 1 (8bit), data of Pixel0-Pixel550		
2	1101	Packet index 2 (8bit), data of Pixel551-Pixel1101		
3	1101	Packet index 3 (8bit), data of Pixel1102-Pixel1652		
4	1101	Packet index 4 (8bit), data of Pixel1653-Pixel2203		
5	1101	Packet index 5 (8bit), data of Pixel2204-Pixel2754		
6	1101	Packet index 6 (8bit), data of Pixel2755-Pixel3305		
7	1101	Packet index 7 (8bit), data of Pixel3306-Pixel3856		
8	621	Packet index 8 (8bit), data of Pixel3857 to end of frame		

Each dataset (except of packet index) consists out of a 16 bit value. For serial order of the datasets refer to section "serial order in Frame".

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#### **Control Messages:**

In the set of control messages, expressions in angled braces have to be substituted by following strings:

[**IP**] insert IP in ASCII format, i.e.: "192.168.240.122"

[MACID] insert MAC ID in ASCII format and hexadecimal, i.e.: "00.1A.22.33.44.55"

[AT] insert index of array types in ASCII format

Array type Index HTPA 8x8 "0" HTPA 16x16 "1" HTPA 32x31 "3" HTPA 64x62 "5"

[MCLK] insert Frequency of MCLK in ASCII format and kHz, i.e.: "1050.1"

[AMP] insert state of amplification in ASCII format:

State String Low "low" High "high"

[MSK] insert subnet mask in ASCII format, i.e.: "255.255.255.000"

[DEVID] insert 5 digit device ID in ASCII format, i.e. "00197" Range: 00000... 65535

#### **Set of control messages:**

Message1: "Calling HTPA series devices" (only Ethernet device)

Conditions: Can be sent as Broadcast, or if device already known as normal packet.

Answer: "HTPA series responsed! I am Arraytype [AT]"

Firmware version, date and author information.

"I am running on [MCLK] kHz"
"Amplification is [AMP]\r\n"
"MAC-ID: [MACID] IP: [IP]\r\n"

A second packet with calibration depending information is send.

Message2: "x Release HTPA series device" (only Ethernet device)

Result: Device disables hardware IP filter. All packets except ARP's, DHCP requests,

Broadcasts, Message1, Message3 and Message4 are discarded.

Answer: "HW-Filter released\r\n"

Message3: "HTPA device IP change request to [IP].[MSK]." (only Ethernet device)

Result: The device changes the IP and the subnet mask to the given value and writes it

to EEPROM. The IP becomes the default IP, therefore the device will use it at

the next reset, if no DHCP is found.

Answer: "Device changed IP to [IP]. and Subnet to [MSK].\r\n"

Message4: "Bind HTPA series device" (only Ethernet device)

Result: Device enables hardware IP filter. Only packets from sender IP, ARP's, DHCP

requests and Broadcasts are accepted. Device accepts now the control

characters listed in Table 1.

Answer: "HW Filter is [IP] MAC [MACID]\n\r""

Insert in the above string the IP and MAC-ID of the Sender from Message4.

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#### **Control Messages [continued]:**

Message5: "Set EEPROM data"

Conditions: Only possible if Message 4 already successful sent.

**ATTENTION!** Calibration data is overwritten!!!

Result: Writes the next received packets into EEPROM, if packet size is equal to 1024

bytes. Device writes to EEPROM, until EEPROM is completely filled. EEPROM size depends on Device type: HTPA8x8, HTPA16x16 and

HTPA32x31: 16384 byte; HTPA64x62: 65536 byte.

Answer: "Write was successful.\n\r"

Message6: "Set DeviceID to [**DEVID**]"

Result: The given Device ID [**DEVID**] is written to EEPROM. This ID is shown on

receive of 'M'. The eDevice ID can be used for customer specific purposes.

Answer: "DeviceID changed to [**DEVID**]\r\n"

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#### **Temperature calculation:**

To get the calibration settings for your device, request a single temperature frame, by sending 'k'. Now the device automatically loaded the settings which were used during calibration. After the receive of the temperature frame request the actual configuration of the device by sending 'M'. Store the information in the line:

"PIXCvsTA *X*, BFL3 *X*, F8\_14 *X*, THvsTA *X* IGNORE\_ELOFF *X* ELOFF32 *X* SBY *Y* FC *X* EXP *Z*". All cursive letters are device dependent constants. Possible strings: *X*="true" or "false", *Y*="1" or "0", *Z* is the string of a 2 digit decimal value, i. e. "3.47". Store those constants, the calculation algorithm is depending on those.

Now load the calibration constants by sending 'w'. The module will send the calibration information, according to Table 3. Store the coloured constants. All stored constants will be labelled according to the value in "Name of constant". If there is no coloured mark in the example string and no insertion in "Name of constant", it is not necessary to store it.

Header of calibration data				
Example String	Name of constant	Unit(s)		
"ASIC-Register @ Calib was 0x402\r\n"				
"Written back 0x402 to ASIC.\r\n"				
"PTAT-gradient 0.569000 dK/dig PTAT-Offset@0V 1973.000000   r\n"	$PTAT_G$ , $PTAT_O$	[dK/dig], [dig]		
"Ambient 1: 285.2 Ambient 2: 295.2 Ambient 3: 310.2 Ambient 4: 324.3 at Calibration\r\n"	$T_{cT1}$ , $T_{cT2}$ , $T_{cT3}$ , $T_{cT4}$	[K]		
"TObj1: 373.2, TObj2: 373.2 TObj3: 373.2 TObj4: 373.2 at Calibration\r\n"				
"TObjcal1: 285.9, TObjcal2: 297.2 TObjcal3: 311.2 TObjcal4: 323.3 at Calibration\r\n"	$T_{cO1}, T_{cO2}, T_{cO3}, T_{cO4}$	[K]		
"Arraytype is 3\r\n"				
"Nr. Thermaloff(1) PixC(1) Thermaloff(2) PixC(2) Thermaloff(3) PixC(3) Thermaloff(4) PixC(4) ThGrad ThOff\r\n"				

Table3: Header of calibration data

<b>Constant:</b>	Meaning:
$PTAT_G$	Gradient of the PTAT circuit in tenths of Kelvin per digits.
$PTAT_O$	Offset of the PTAT circuit in digits.
$T_{cT1}$	Absolute ambient temperature during calibration of the thermal offsets in calibration point 1.
$T_{cT2}$	Absolute ambient temperature during calibration of the thermal offsets in calibration point 2.
$T_{cT3}$	Absolute ambient temperature during calibration of the thermal offsets in calibration point 3.
$T_{cT4}$	Absolute ambient temperature during calibration of the thermal offsets in calibration point 4.
$T_{cO1}$	Absolute ambient temperature during calibration of the pixel constants in calibration point 1.
$T_{cO2}$	Absolute ambient temperature during calibration of the pixel constants in calibration point 2.
$T_{cO3}$	Absolute ambient temperature during calibration of the pixel constants in calibration point 3.
$T_{cO4}$	Absolute ambient temperature during calibration of the pixel constants in calibration point 4.

**Table4:** Meaning of constants (1)

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After the header the pixel dependent constants are immediately transmitted. The number of packets (UDP) or lines (UART) depends on the device type and is equal to the number of sensitive pixels. Each packet / line consists of:

Pixelnumber, Thermal1(X), Pixelconstant1(X), Thermal2(X), Pixelconstant2(X), Thermal3(X), Pixelconstant3(X), Thermal4(X), Pixelconstant4(X).

X represents in the above line the corresponding pixel number.

Store all the pixel dependent constants.

	Pixel dependent calibration data					
No.	<b>Example String</b>	Name of constant	Comments			
0	"0 <mark>127   1316732   112   1182251   98   1126390   72   849857</mark> "	$Th_1(0)$ , $P_1(0)$ , $Th_2(0)$ , $P_2(0)$ , $Th_3(0)$ , $P_3(0)$ , $Th_4(0)$ , $P_4(0)$ ,	Number of dataset grey marked			
1	"1 <mark>137   1396731   132   1482251   128   1516391   127  </mark> 1549867"	$Th_1(1)$ , $P_1(1)$ , $Th_2(1)$ , $P_2(1)$ , $Th_3(1)$ , $P_3(1)$ , $Th_4(1)$ , $P_4(1)$ ,	Number of dataset grey marked			
N	"N 127 1516732 112 1182251 98 1126390 72 849857"	$Th_1(N)$ , $P_1(N)$ , $Th_2(N)$ , $P_2(N)$ , $Th_3(N)$ , $P_3(N)$ , $Th_4(N)$ , $Th_4(N)$ , $Th_4(N)$ , $Th_4(N)$ , $Th_4(N)$ ,	N equals the number of pixels-1.  HTPA8x8→N=63  HTPA16x16→N=255  HTPA32x31→N=991			

**Table5:** Pixel dependent calibration data

<b>Constant:</b>	Meaning:	
$Th_1(X)$	Thermal offset of Pixel X in digits at the thermal calibration point $1 \rightarrow T_{cT1}$	
$Th_2(X)$	Thermal offset of Pixel X in digits at the thermal calibration point $2 \rightarrow T_{cT2}$ .	
$Th_3(X)$	Thermal offset of Pixel X in digits at the thermal calibration point $3 \rightarrow T_{cT3}$	
$Th_4(X)$	Thermal offset of Pixel X in digits at the thermal calibration point $4 \rightarrow T_{cT4}$	
$P_1(X)$	Pixel constant of Pixel X at the object calibration point $1 \rightarrow T_{cO1}$	
$P_2(X)$	Pixel constant of Pixel X at the object calibration point $2 \rightarrow T_{cO2}$	
$P_3(X)$	Pixel constant of Pixel X at the object calibration point $3 \rightarrow T_{cO3}$	
$P_4(X)$	Pixel constant of Pixel X at the object calibration point $4 \rightarrow T_{cO4}$	

**Table6:** Meaning of constants (2)

The calibration is done with four different ambient temperature calibration points for Thermals and pixel constants, each.

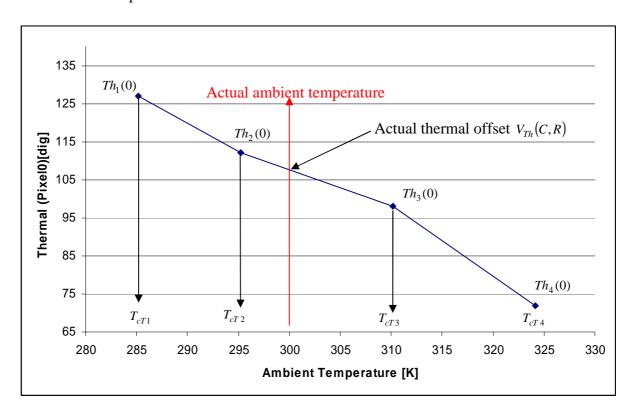
Therefore, it is useful to calculate a gradient and an offset (each for thermal offsets and pixel constants) between two calibration points and to do a linear interpolation between the two calibration points, which are the closest to the actual ambient temperature. This will provide the highest accuracy.

For the following example we took the data of Pixel0, provided in Table 3 and Table 5. The linear interpolation is shown at the example of the thermal offset. Assume an actual ambient temperature of 300 K. Refer to chapter "Ambient temperature" for ambient temperature calculation.

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Calculation example for actual thermal offset of Pixel 0 at 300 Kelvin:



To calculate the actual thermal offset  $V_{Th}(C,R)$  a linear interpolation is sufficient. (C,R) represents the column and row dependency of the value. The same proceeding for the pixel constants is recommended.

#### **Ambient Temperature:**

Calculate the ambient temperature by following equation:

$$T_{Amb} = \frac{\sum_{i=0}^{N} PTAT_{i}}{N+1} \cdot PTAT_{G} + PTAT_{O} \text{ [dK]}$$

 $T_{Amb}$  is the actual ambient temperature in tenths of Kelvin.

PTAT<sub>i</sub> represents the N current PTAT-values, refer to Table 2. N is device dependent.

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#### **Object Temperature:**

In the followings dependency of the column is displayed as variable-name (C). Dependency of row and column (pixel dependent) is displayed as variable-name (C,R).

The transmitted absolute pixel voltage consist of the electrical offset of the amplifier  $V_{eloff}(C)$ , the thermal offset of the pixel  $V_{Th}(C,R)$  and the amplified pixel voltage  $V_{Pix}(C,R)$ :

$$V_{Abs}(C,R) = V_{Pix}(C,R) + V_{Th}(C,R) + V_{elOff}(C)$$

For the HTPA8x8 and the HTPA16x16 the corresponding electrical offset to a pixel voltage can be determined by the modulo-n-check. Divide the pixel number by the number of amplifiers (refer to the datasheet of the sensor), the residue is the corresponding electrical offset. For the HTPA32x31 the column address of the pixel is equal to the number of the electrical offset value.

If your device has a calibration setting of "IGNORE\_ELOFF false" it is necessary to subtract the corresponding electrical offset of the amplifier  $V_{elOff}(C)$  from the transmitted absolute Voltage of the pixel, else the electrical offset can be set to zero.

IGNORE\_ELOFF false 
$$\rightarrow V_{Abs}(C,R) - V_{elOff}(C) = V_{Pix}(C,R) + V_{Th}(C,R)$$
  
IGNORE\_ELOFF true  $\rightarrow V_{Abs}(C,R) = V_{Pix}(C,R) + V_{Th}(C,R)$ 

The next step is to subtract the corresponding thermal offset to get the amplified pixel voltage: IGNORE\_ELOFF false  $\rightarrow V_{Pix}(C,R) = V_{Abs}(C,R) - V_{elOff}(C) - V_{Th}(C,R)$ IGNORE\_ELOFF true  $\rightarrow V_{Pix}(C,R) = V_{Abs}(C,R) - V_{Th}(C,R)$ 

As described before, the value of  $V_{Th}(C,R)$  should be determined by a linear interpolation between the two thermal offset values out of  $Th_1(C,R)$ ,  $Th_2(C,R)$ ,  $Th_3(C,R)$ ,  $Th_4(C,R)$ , which are as closest to the actual ambient temperature.

Next step is the linear interpolation to get the actual pixel constant PixC(C,R), in dependency of the current ambient temperature  $T_{Amb}$ .

Now the object temperature  $T_0$  in tenths of Kelvin can be calculated by:

$$T_{O} = \sqrt[X]{\frac{V_{Pix}(C,R) \cdot PixC(C,R) \cdot VDM}{\varepsilon} + T_{Amb}^{X}}$$
 [dK]

 $\varepsilon$  is the emission coefficient of the surface the pixel is receiving the radiation from. VDM is a multiplier, which is equal to the VDM constant.

*X* is an exponent, which is equal to the EXP constant. VDM and EXP can be both obtained with the control character 'M'.